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FAN5701 — Compact 6-LED Driver for Mobile Platforms

Features

- Six (6) Parallel LEDs (up to 30mA each)
- Total Package Load Current Capability: 180mA
- Two Default Groups of Four (4) and Two (2) LEDs for Main and Sub-Display Lighting with Individual PWM Dimming Controls that Operate up to 20kHz
- >600:1 Dimming Ratio for 100Hz PWM Frequency
- Up to 92% Efficiency
- Built-in 1.5x Charge Pump with Low-Dropout Bypass Switch
- Wide Input Range: 2.7V to 5.5V
- V_{OUT} Over-Voltage and Short-Circuit Protection
- Over-Temperature Protection
- 1.2MHz Switching Frequency for Small-Sized Capacitors
- 16-Bump 1.61mm x 1.61mm WLCSP (0.6mm Height)
- 16-Lead 3.0mm x 3.0mm UMLP (0.55mm Height)

Applications

- LCD Backlighting
- Keypad Backlighting
- Mobile Handsets
- Portable Media Player

Description

The FAN5701 is a highly integrated and efficient chargepump-based multi-LED driver. The device can drive up to six LEDs in parallel with a total output current of 180mA.

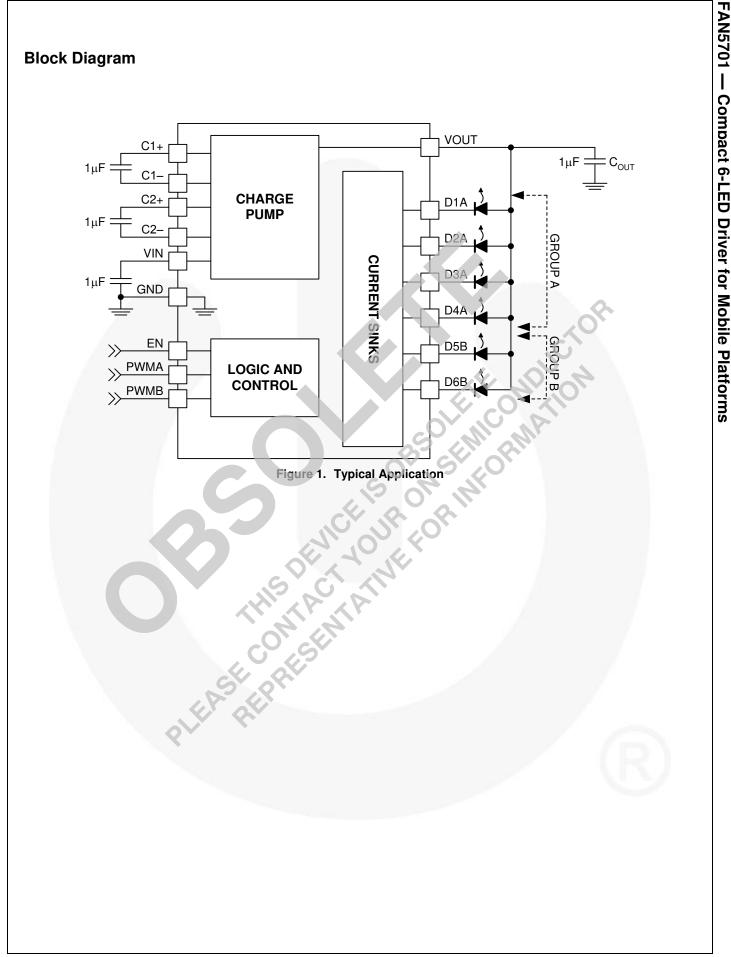
The FAN5701 is capable of driving a primary display backlight requiring four to six LEDs. When more than four LEDs are needed for backlighting, the FAN5701's two PWM dimming inputs can be connected together to provide the proper dimming control for all six LEDs. When a primary and sub-display is needed, the FAN5701 can be controlled such that each group can be dimmed independently. For candy-bar phones requiring a primary display and keypad lighting, the FAN5701 offers a simple, and compact lighting solution.

Regulated internal current sinks deliver excellent current and brightness matching to all six LEDs. The device provides excellent efficiency without an inductor by operating the charge pump in 1.5x or pass-through modes.

WLCSP (0.6mm Height) YLP (0.55mm Height)

Ordering Information

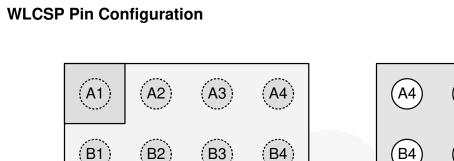
-				
Part Number	LED Current (I _{SET})	Temperature Range	Package	Packing
FAN5701UC30X	30mA	-40°C to 85°C	WLCSP-16, 0.4mm Pitch	Tape and Reel
FAN5701UC20X	20mA	-40°C to 85°C	WLCSP-16, 0.4mm Pitch	Tape and Reel
FAN5701UC15X	15mA	-40°C to 85°C	WLCSP-16, 0.4mm Pitch	Tape and Reel
FAN5701UC08X	8mA	-40°C to 85°C	WLCSP-16, 0.4mm Pitch	Tape and Reel
FAN5701UMP30X	30mA	-40°C to 85°C	UMLP-16, 3.0 x 3.0 x 0.55mm	Tape and Reel
FAN5701UMP20X	20mA	-40°C to 85°C	UMLP-16, 3.0 x 3.0 x 0.55mm	Tape and Reel
FAN5701UMP15X	15mA	-40°C to 85°C	UMLP-16, 3.0 x 3.0 x 0.55mm	Tape and Reel
FAN5701UMP08X	8mA	-40°C to 85°C	UMLP-16, 3.0 x 3.0 x 0.55mm	Tape and Reel

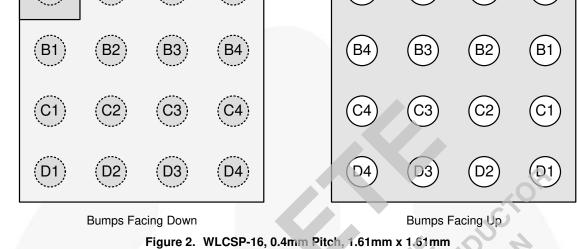


A1

A3

A2

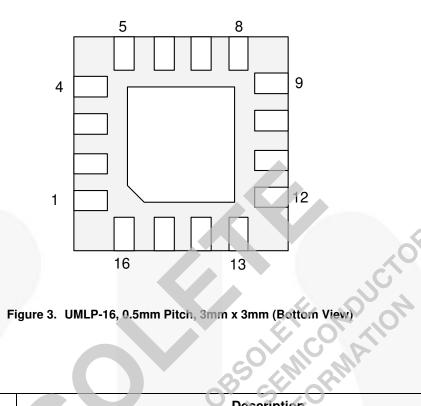




Pin Definitions

		Figure 2. WLCSP-16, 0.4mm Pitch, 1.61mm X 1.51mm
Pin Definiti	ions	SOLFICONATIO
Pin #	Name	Description
D2	VIN	Input Voltage. Connect to 2.7 – 5.5Vpc input power source.
B4	GND	Ground
D1	VOUT	Charge Pump Output Voltage. Connect to LED Anodes.
D3,D4	C1+, C1-	C1. Charge pump flying capacitor #1.
C3,C4	C2+, C 2–	C2. Charge pump flying capacitor #2.
A1, A2, B1, B2, C1, C2	D2A, D1A, D4A, D3A, D6B, D5B	LED Outputs
A4	EN	Enable . When this pin is HIGH, normal operation is enabled. When LOW, the IC is reset and all functions are disabled.
B3	PWMA	Group-A PWM Dimming Input
A3	PWMB	Group-B PWM Dimming Input

UMLP Pin Configuration





Pin Definitions

Pin #	Name	Description
11	VIN	Input Voltage. Connect to 2.7 – 5.5V _{DC} input power source.
6	GND	Ground
12	VOUT	Charge Pump Output Voltage. Connect to LED Anodes.
10,9	C1+, C1-	C1. Charge pump flying capacitor #1.
8,7	C2+, C2-	C2. Charge pump flying capacitor #2.
1 ,2, 15, 16, 13, 14	D2A, D1A, D4A, D3A, D6B, D5B	LED Inputs
4	EN	Enable . When this pin is HIGH, normal operation is enabled. When LOW, the IC is reset and all functions are disabled.
5	PWMA	Group-A PWM Dimming Input
3	PWMB	Group-B PWM Dimming Input

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter				Min.	Max.	Units	
V	VIN, VOUT Pins					-0.3	6.0	V
Vcc	Other Pins ⁽¹⁾					-0.3	$AV_{IN} + 0.3$	V
		Human Body Model, JESD22-A		4			3	
	Electrostatic Discharge Protection Level	Charged Device Model, JESD22-C101 UMLP16		2		kV		
		Charged Devi	ice Model, JESD22-0	C101	WLCSP-16	1		
TJ	Junction Temperature					-40	+150	°C
T _{STG}	Storage Temperature			-65	+150	°C		
TL	Lead Soldering Temperature, 10 Seconds				+260	°C		

Note:

1. Lesser of V_{IN} + 0.3 or 6.0V.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V _{IN}	Supply Voltage	2.7	5.5	V
V _{LED}	LED Forward Voltage	2	4	V
T _A	Ambient Temperature	-40	+85	°C
TJ	Junction Temperature	-40	+125	°C

Thermal Properties

Symbol	Parameter		Min.	Тур.	Max.	Units
0	Junction to Ambient Thermal Desistance ⁽²⁾	WLCSP		80	/	°C/W
Θ _{JA}	Junction-to-Ambient Thermal Resistance ⁽²⁾	UMLP		49		°C/W

Note:

 Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards in accordance to JESD51- JEDEC standard. Special attention must be paid not to exceed junction temperature T_{J(max)} at a given ambient temperate T_A.

Electrical Specifications

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Power Sup	plies and Thermal Protection	•		•		
		1.5x Mode, No LEDs		4.4		mA
Ι _Q	Quiescent Supply Current	1x Mode, No LEDs		0.7		mA
I _{SD}	Shutdown Supply Current	$EN = 0$, $V_{IN} = 4.5V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$		1.5	4.0	μA
M	Under-Voltage Lockout	V _{IN} Rising		2.55 2.70		V
V _{UVLO}	Threshold	V _{IN} Falling	2.20	2.40		V
V _{UVHYST}	Under-Voltage Lockout Hysteresis			150		mV
OVP	Over-Voltage Protection			6		V
T _{LIMIT}	Thermal Shutdown			150	0	°C
T _{HYST}	Thermal Shutdown Hysteresis			20		°C
LED Currer	nt Sinks			.C		
I _{LED}	Absolute Current Accuracy	V _{CATHODE} =0.4V, See Options for I _{SET}	-10%	ISET	+10%	mA
ILED(MAX)	Maximum Diode Current (3)	ILED= ISET		30		mA
ILED_MATCH	LED Current Matching (4)	V _{CATHODE} =0.4V, I _{LED} = I _{SET}	0	0.4	3.0	%
V _{DTH}	1x to 1.5x Gain Transition Threshold	LED Cathode Voltage Falling	A	100		mV
V _{HR}	Current Sink Headroom (5)	ILED = 90% ILED(NOMINAL)	5	65		mV
Charge Pur	np	S R I				
		1.5x Mode		2.4		Ω
Rout	Output Resistance	1x Mode		0.9		Ω
f _{sw}	Switching Frequency	1.00.00	0.9	1.2	1.5	MHz
t start	Startup Time	Vour = 90% of Steady State		250		μs
PWM Dimm	ing	SCA				
f _{PWM}	PWM Dimming Frequency	t _{on_LED} = 15µs (Minimum)			20	kHz
D _{PWM}	PWM Duty-Cycle	f _{PWM} = 100Hz	0.15		100.00	%
Logic Input	s (EN, PWMA, PWMB)	0 6				
V _{IH}	HIGH-Level Input Voltage		1.2			V
V _{IL}	LOW-Level Input Voltage				0.4	V
VIMAX	Maximum Input Voltage			1.8	5.5	V
I _{IN}	Input Bias Current	Input Tied to GND or V _{IN}		0.01	1.00	μA

Unless otherwise specified; $V_{IN} = 2.7V$ to 5.5V, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, and $EN = V_{IN}$. Typical values are $V_{IN} = 3.6V$, $T_A = 25^{\circ}C$, $I_{LED} = 20$ mA, and LED cathode terminals = 0.4V. Circuit and components are according to Figure 1.

Notes:

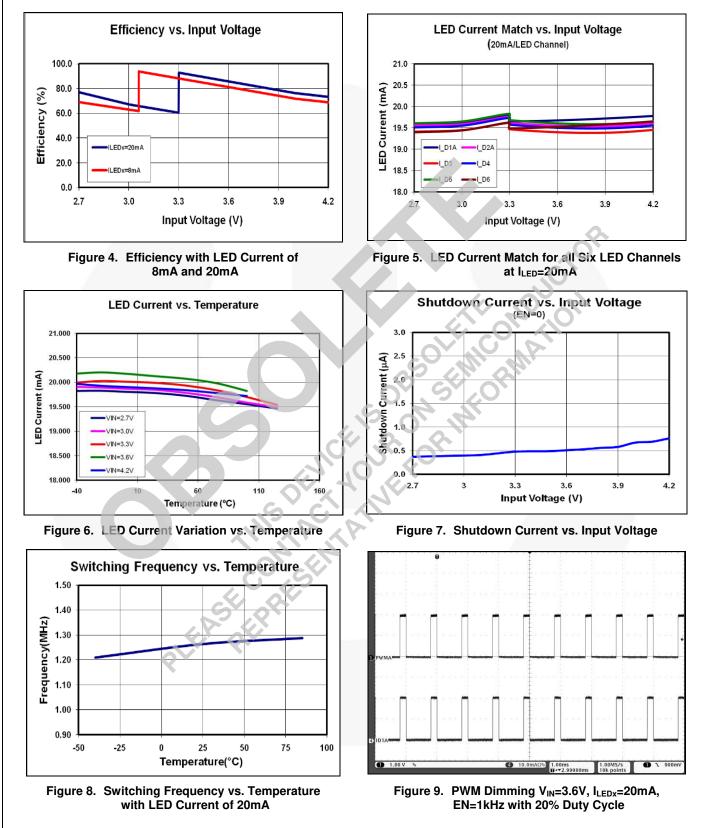
3. The maximum total output current for the IC should be limited to 180mA. The total output current can be split between the two groups (IDxA = IDxB = 30mA maximum). Under maximum output current conditions, special attention must be given to input voltage and LED forward voltage to ensure proper current regulation. See the Maximum Output Current section of the datasheet for more information.

4. For the two groups of current sinks on a part (GroupA and GroupB), the following are determined: the maximum sink current in the group (MAX), the minimum sink current in the group (MIN), and the average sink current of the group (AVG). For each group, two matching numbers are calculated: (MAX-AVG)/ AVG and (AVG-MIN)/AVG. The largest number of the two (worst case) is considered the matching figure for the group. The matching figure for a given part is considered to be the highest matching figure of the two groups. The typical specification provided is the most likely norm of the matching figure for all parts.

For each Dxx pin, headroom voltage is the voltage across the internal current sink connected to that pin. V_{HRx} = V_{OUT} - V_{LED}. If headroom voltage requirement is not met, LED current regulation is compromised.

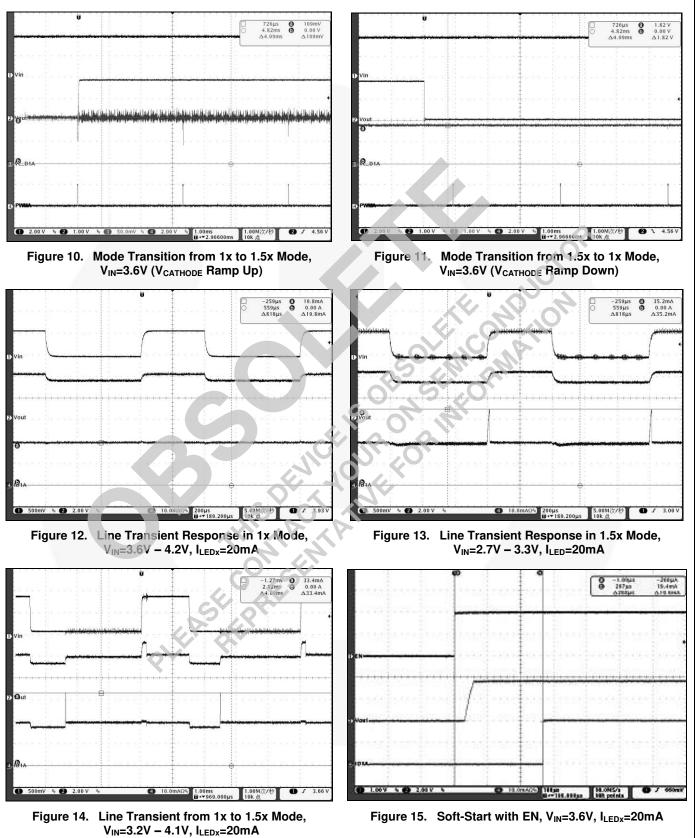
Typical Characteristics

 V_{IN} = 3.6V, T_{A} = 25°C, I_{LED} = 20mA, and LED cathode terminals = 0.4V.



Typical Characteristics (Continued)

 V_{IN} = 3.6V, T_{A} = 25°C, I_{LED} = 20mA, and LED cathode terminals = 0.4V.



Circuit Description

The FAN5701 is a white LED driver system based upon an adaptive 1.5x/1x charge pump capable of supplying up to 180mA of total output current. The tightly matched current sinks ensure uniform brightness across the LEDs. Each LED is configured in a common anode configuration with its peak drive current set during manufacturing (see Ordering Information and I_{SET}).

Charge Pump

The charge pump operates in either 1x mode, where VOUT is connected to VIN through a bypass switch, or in 1.5x mode. The circuit operates in 1x mode until the LED with the highest forward voltage ($V_{LED(MAX)}$) can no longer maintain current regulation. At that point, 1.5x mode begins. If the lowest active cathode voltage is greater than 1.8V, the charge pump switches back to 1x mode.

In addition to hysteresis, a 1ms transition delay is provided for the device to ignore short-duration input voltage drops in deciding mode transitions.

IC Enable

When the EN pin is LOW, all circuit functions are disabled. When the EN pin HIGH, the entire chip is enabled. Both PWM inputs are now functional.

PWM Dimming

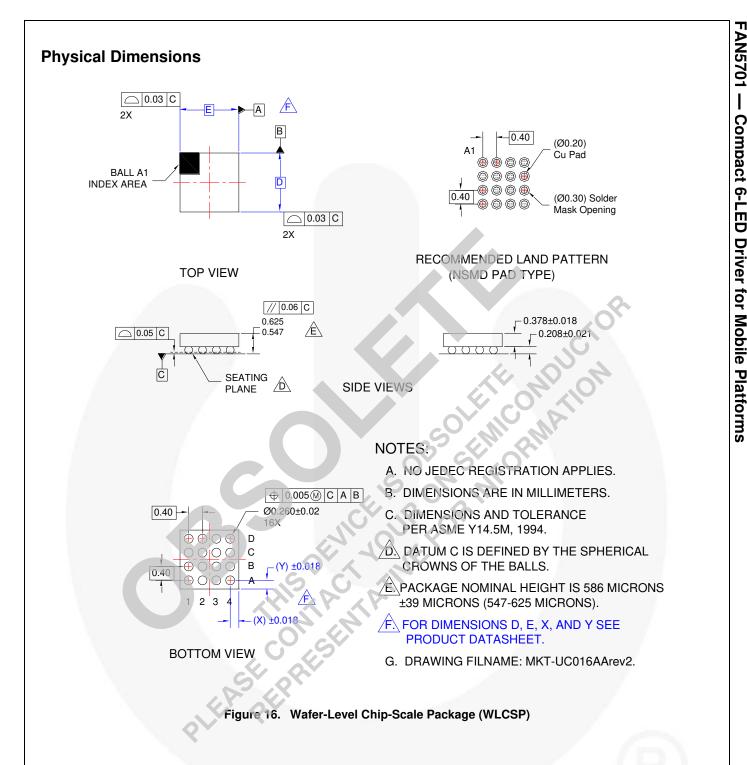
External PWM inputs (group A and group B) directly modulate output currents in their corresponding LED channels to vary the perceived LED brightness. Two PWM inputs are provided to control two independent groups of LEDs, such as that of a main display panel and a secondary panel. They can also be connected to a single input to simultaneously dim all six LED outputs.

Vout Short-Circuit Protection

The FAN5701 has integrated protection circuitry to prevent the device from being snort circuited when the output voltage falls below 2V. If this occurs FAN5701 turns off the charge pump and the LED driver outputs, but a small bypass switch is left on. The device monitors the output voltage to determine if it is still in short circuit condition and, once it has passed, FAN5701 soft-starts and returns to normal operation.

Vour Over-Voltage Protection

If the output voltage goes above 6V, the FAN5701 shuts down until this condition has passed. The charge pump and LED driver outputs are turned off. Once this condition has passed, FAN5701 soft-starts into normal operation.

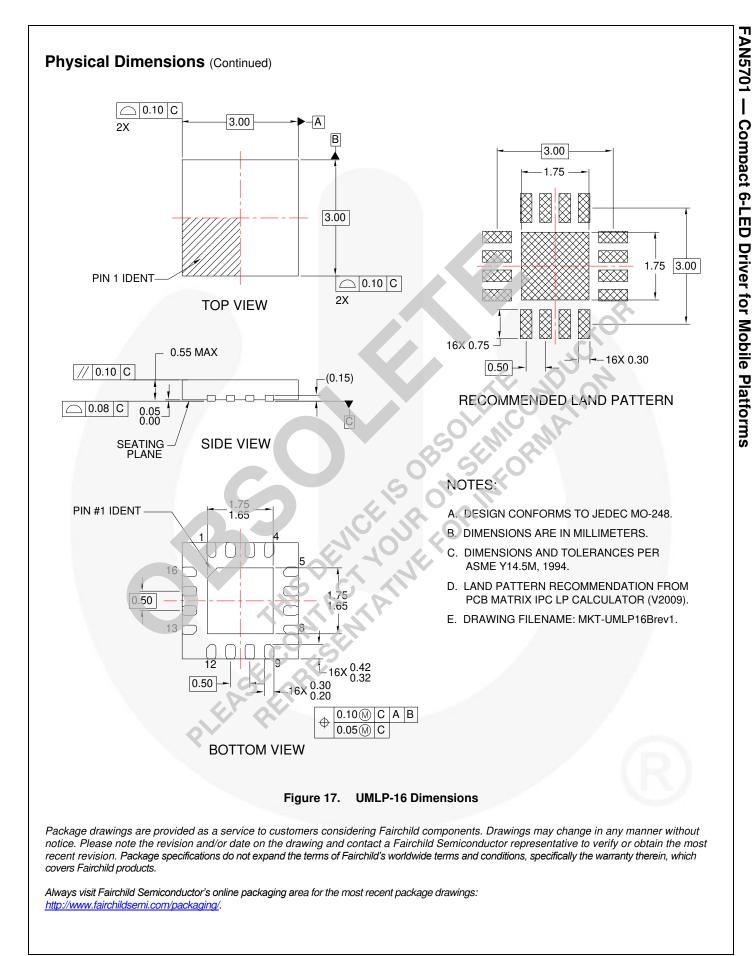


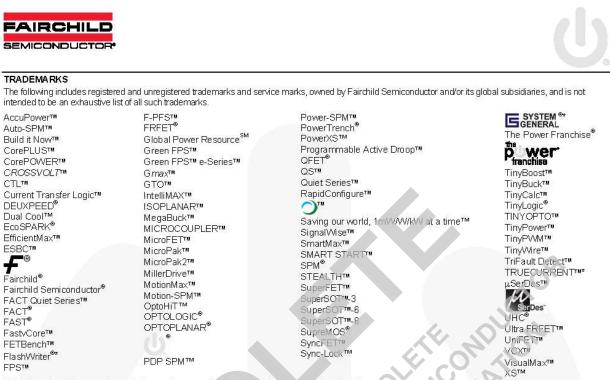
Product-Specific Dimensions

Product	D	E	X	Y
FAN5701UCxx	1.610mm	1.610mm	0.205mm	0.205mm

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Rev. 149

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Compact 6-LED Driver for Mobile

Platforms

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